OctalNAND Flash

fast, low-cost alternative to Octal NOR Flash in densities of 1Gbit and higher

General Description

The world’s first x8 Octal interface for NAND Flash, Winbond’s OctalNAND Flash enables automotive and industrial manufacturers to provide code storage in high density without having to pay a premium for NOR Flash, a fast memory technology which scales poorly at densities above 512Mbits.

The first Winbond product to include the new interface, the 1Gbit W35N01JW, offers a maximum continuous Read throughput of 240MB/s, three times faster than the earlier high-performance W25N-JW Quad Serial NAND Flash family. The single-die W35N01JW is also 50% faster than Winbond’s W72N-JW family of Dual Quad Serial NAND devices, which have dual dies in a single package, and a more complex x2/x4/x8 I/O architecture.

Manufactured in Winbond’s proven 46nm Single Level Cell (SLC) NAND fabrication process, the W35N-JW OctalNAND Flash offers excellent data integrity and more than ten years’ data retention. It is specified to perform more than 100,000 Program/Erase cycles, providing the high level of endurance and reliability required in mission-critical automotive and industrial applications.
Applications

Automotive
- Instrument Cluster Applications
- Fast Booting

Consumer
- Fast Booting

Package Information

<table>
<thead>
<tr>
<th>Voltage</th>
<th>Density</th>
<th>Part Number</th>
<th>Speed (MHz)</th>
<th>I/O</th>
<th>Package</th>
</tr>
</thead>
<tbody>
<tr>
<td>1.8V</td>
<td>1Gb</td>
<td>W35N01JW</td>
<td>166 MHz (STR)</td>
<td>x1/x8</td>
<td>BGA24</td>
</tr>
<tr>
<td></td>
<td>2Gb</td>
<td>W35N02JW</td>
<td>120 MHz (DTR)</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>4Gb</td>
<td>W35N04JW</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

* See data sheet for further technical information. This is subject to change without notice.

Own Logic and Memory Technology

Winbond Electronics Corp. is an Integrated IC Company engaged in IC design, manufacturing and sales services. From product design, research and development, wafer fabrication to marketing of brand name product, Winbond endeavors to provide its global clientele top quality of low to medium density memory solutions.

Own 12-inch Fab

Winbond specializes in the design of high-performance, low-power memory, and riding on the strength of having a 12-inch fab, offers a whole series of SLC code storage NAND flash memory and Mobile DRAM. The in house wafer fabrication provides customers with full commitment in capacity support as well as delivery flexibility.